

M-MOS Semiconductor Hong Kong Limited

30V P-Channel Enhancement-Mode MOSFET

 $V_{DS} = -30V$

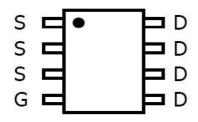
 $R_{DS(ON)}$, V_{gs} @-10V, I_{ds} @-5.3A = 60m Ω

 $R_{DS(ON)}$, V_{gs} @-4.5V, I_{ds} @-4.2A = 90m Ω

Features

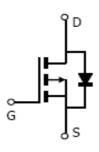
Advanced trench process technology High Density Cell Design For Ultra Low On-Resistance Improved Shoot-Through FOM

SOP-08



Top View

Internal Schematic Diagram



P-Channel MOSFET

Maximum Ratings and Thermal Characteristics ($T_A = 25^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	-30	V		
Gate-Source Voltage	V_{GS}	± 20	V		
Continuous Drain Current		I _D	-5.3	^	
Pulsed Drain Current 1)		I _{DM}	-20	A	
Maximum Power Dissipation	TA = 25°C	P _D	2.5	W	
	TA = 75°C		1.2	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C	
Junction-to-Case Thermal Resistance		R _{eJC}	24	°C/W	
Junction-to-Ambient Thermal Resistance (PCB mounted) 2)		$R_{ heta JA}$	62.5		

Note: 1. Repetitive Rating: Pulse width limited by the maximum junction temperature

2. 1-in² 2oz Cu PCB board

V 1.2





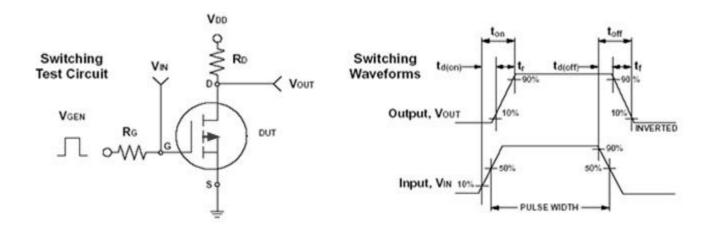
P-Channel Enhancement-Mode MOSFET

ELECTRICAL CHARACTERISTICS

Symbol	Test Condition	Min	Тур	Max	Unit
BV _{DSS}	$V_{GS} = 0V, I_D = -250uA$	-30			V
R _{DS(on)}			52.0	60.0	mΩ
R _{DS(on)}			70.0	90.0	
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250$ uA	-1	-1.4	-3	V
I _{DSS}	$V_{DS} = -30V, V_{GS} = 0V$			1	uA
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Q_g	V_{DS} =-15V, I_{D} = -4.9A V_{GS} = -10V		9.0		nC
Q_{gs}			2.2		
Q_{gd}			1.8		
t _{d(on)}	$V_{DD} = -15V, R_{L} = 15 \Omega$ $I_{D} = -1A, V_{GEN} = -10V$ $R_{G} = 6\Omega$		9.1		ns
t _r			2.8		
t _{d(off)}			19.2		
t _f			4.9		
C _{iss}	V _{DS} = -15V, V _{GS} = 0V f = 200 KHz		486.2		pF
C _{oss}			66.0		
C _{rss}			50.0		
Is				-2.6	А
V _{SD}	$I_S = 2.6A, V_{GS} = 0V$			-1.3	V
	BV _{DSS} R _{DS(on)} R _{DS(on)} V _{GS(th)} I _{DSS} I _{GSS} Q _g Q _{gs} Q _{gd} t _{d(on)} t _r t _{d(off)} t _f C _{iss} C _{oss} C _{rss}	$\begin{array}{ c c c } & BV_{DSS} & V_{GS} = 0V, \ I_D = -250uA \\ & R_{DS(on)} & V_{GS} = -10V, \ I_D = -5.3A \\ & R_{DS(on)} & V_{GS} = -4.5V, \ I_D = -4.2A \\ & V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = -250uA \\ & I_{DSS} & V_{DS} = -30V, \ V_{GS} = 0V \\ & I_{GSS} & V_{GS} = \pm 20V, \ V_{DS} = 0V \\ & Q_g & V_{DS} = -15V, \ I_D = -4.9A \\ & V_{GS} = -10V \\ & Q_{gd} & t_{d(on)} \\ & t_r & V_{DD} = -15V, \ R_L = 15\Omega \\ & I_D = -1A, \ V_{GEN} = -10V \\ & R_G = 6\Omega \\ & t_f & C_{iss} \\ & C_{oss} & V_{DS} = -15V, \ V_{GS} = 0V \\ & I_{S} = -200 \ \text{KHz} \\ & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\ & I_{S} & I_{S} & I_{S} & I_{S} \\$	$ \begin{array}{ c c c c } \hline BV_{DSS} & V_{GS} = 0V, \ I_D = -250uA & -30 \\ \hline R_{DS(on)} & V_{GS} = -10V, \ I_D = -5.3A & \\ \hline R_{DS(on)} & V_{GS} = -4.5V, \ I_D = -4.2A & \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = -250uA & -1 \\ \hline I_{DSS} & V_{DS} = -30V, \ V_{GS} = 0V & \\ \hline I_{GSS} & V_{GS} = \pm 20V, \ V_{DS} = 0V & \\ \hline \hline Q_g & & & & & & \\ \hline Q_{gd} & & & & & \\ \hline Q_{gd} & & & & & \\ \hline U_{DS} = -15V, \ I_D = -4.9A & \\ \hline Q_{gd} & & & & \\ \hline U_{DD} = -15V, \ R_L = 15\Omega & \\ \hline U_{D} = -1A, \ V_{GEN} = -10V & \\ \hline U_{GSS} & & & & \\ \hline U_{DS} = -15V, \ V_{GS} = 0V & \\ \hline U_{DS} = -15V, \ V_{GS} = 0V & \\ \hline U_{DS} = -15V, \ V_{GS} = 0V & \\ \hline U_{DS} = -15V, \ V_{GS} = 0V & \\ \hline U_{DS} = -15V, \ V_{GS} = 0V & \\ \hline U_{DS} = -15V, \ V_{CS} = 0V & \\ \hline U_{DS} = -15V, \ U_{DS} = 0V & \\ \hline U_{DS} = -15V, \ U_{DS} = 0V & \\ \hline U_{DS} = -15V, \ U_{DS} = 0V & \\ \hline U_{DS} = -15V, \ U_{DS} $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c } \hline BV_{DSS} & V_{GS} = 0V, \ I_D = -250uA & -30 & \\ \hline R_{DS(on)} & V_{GS} = -10V, \ I_D = -5.3A & 52.0 & 60.0 \\ \hline R_{DS(on)} & V_{GS} = -4.5V, \ I_D = -4.2A & 70.0 & 90.0 \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = -250uA & -1 & -1.4 & -3 \\ \hline I_{DSS} & V_{DS} = -30V, \ V_{GS} = 0V & 1 \\ \hline I_{GSS} & V_{GS} = \pm 20V, \ V_{DS} = 0V & \pm 100 \\ \hline \hline Q_g & V_{DS} = -15V, \ I_D = -4.9A & 2.2 \\ \hline Q_{gd} & V_{DS} = -10V & 1.8 \\ \hline t_{d(on)} & 9.1 & \\ \hline t_r & V_{DD} = -15V, \ R_L = 15 \Omega \\ \hline I_D = -1A, \ V_{GEN} = -10V & 19.2 \\ \hline t_f & 1.9 = -15V, \ V_{GS} = 0V & 66.0 \\ \hline C_{css} & V_{DS} = -15V, \ V_{GS} = 0V & 66.0 \\ \hline C_{rss} & 0.0 & 50.0 \\ \hline \end{array} $

Note: Pulse test: pulse width <= 300us, duty cycle<= 2%

^{3.} Guaranteed by design; not subject to production testing



V 1.2



Notice

- 1. Specification of the products displayed herein are subject to change without notice. Continuous development may necessitate changes in technical data without notice. M-MOS Semiconductor Sdn. Bhd. or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.
- 2. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

V 1.2